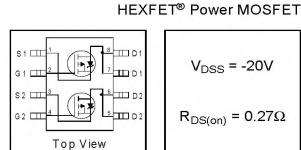
International IOR Rectifier

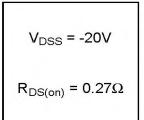
- Generation V Technology
- Ultra Low On-Resistance
- Dual P-Channel MOSFET
- Very Small SOIC Package
- Low Profile (<1.1mm)
- Available in Tape & Reel
- Fast Switching
- Lead-Free

Description

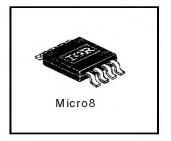
Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The new Micro8 package, with half the footprint area of the standard SO-8, provides the smallest footprint available in an SOIC outline. This makes the Micro8 an ideal device for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro8 will allow it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.





IRF7504PbF



Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ -4.5V	-1.7	
$I_D @ T_A = 70^{\circ}C$ Continuous Drain Current, $V_{GS} @ -4.5V$		-1.4	A
I _{DM}	Pulsed Drain Current ①	-9.6	
P _D @T _A = 25°C	Power Dissipation	1.25	W
	Linear Derating Factor	10	mW/°C
V _{GS}	Gate-to-Source Voltage	± 12	٧
dv/dt	Peak Diode Recovery dv/dt ②	-5.0	V/ns
T _{J,} T _{STG}	Junction and Storage Temperature Range	-55 to + 150	°C

Thermal Resistance

	Parameter	Тур.	Max.	Units
Reja	Maximum Junction-to-Ambient ⊕		100	°CM

All Micro8 Data Sheets reflect improved Thermal Resistance, Power and Current -Handling Ratings- effective only for product marked with Date Code 505 or later .

International
Rectifier

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	-20			٧	$V_{GS} = 0V$, $I_{D} = -250\mu A$
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient		-0.012	1	V/°C	Reference to 25°C, I _D = -1mA
Ď	Static Drain-to-Source On-Resistance	-		0.27	Ω	V _{GS} = -4.5V, I _D = -1.2A ③
R _{DS(ON)}			-	0.40		V _{GS} = -2.7V, I _D = -0.60A ③
V _{GS(th)}	Gate Threshold Voltage	-0.70			٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
g fs	Forward Transconductance	1.3	-	n '	S	V _{DS} = -10V, I _D = -0.60A
I _{DSS}	Drain-to-Source Leakage Current	_		-1.0	μA	V _{DS} = -16V, V _{GS} = 0V
		_		-25		V _{DS} = -16V, V _{GS} = 0V, T _J = 125°C
Lead	Gate-to-Source Forward Leakage			-100	nΑ	V _{GS} = -12V
I _{GSS}	Gate-to-Source Reverse Leakage	-	-	100	шА	V _{GS} = +12V
Qg	Total Gate Charge		5.4	8.2		I _D = -1.2A
Qgs	Gate-to-Source Charge		0.96	1.4	nC	V _{DS} = -16V
Qgd	Gate-to-Drain ("Miller") Charge	-	2.4	3.6		V _{GS} = -4.5V, See Fig. 6 and 9 ③
t _{d(on)}	Turn-On Delay Time		9.1) 		V _{DD} = -10V
tr	Rise Time		35		no	I _D = -1.2A
t _{d(off)}	Turn-Off Delay Time	_	38		ns	$R_G = 6.0\Omega$
tf	Fall Time		43			$R_D = 8.3\Omega$, See Fig. 10 ③
Ciss	Input Capacitance		240	_		V _{GS} = 0V
Coss	Output Capacitance	_	130	-	pF	V _{DS} = -15V
C _{rss}	Reverse Transfer Capacitance		64			f = 1.0MHz, See Fig. 5

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Is	Continuous Source Current (Body Diode)	-	_	-1.25	A	MOSFET symbol showing the	
Ism	Pulsed Source Current (Body Diode) ①	1-	_	-9.6	^	integral reverse p-n junction diode.	
V _{SD}	Diode Forward Voltage			-1.2	٧	$T_J = 25$ °C, $I_S = -1.2$ A, $V_{GS} = 0$ V ③	
t _m	Reverse Recovery Time		52	78	ns	T _J = 25°C, I _F = -1.2A	
Q _{rr}	Reverse RecoveryCharge		63	95	nC	di/dt = 100A/µs ③	
ton	Forward Turn-On Time	Intrinsic tum-on time is negligible (tum-on is dominated by L_S + L_D)					

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{l} @ I_{SD} \le -1.2A, \ di/dt \le 100A/\mu s, \ V_{DD} \le V_{(BR)DSS}, \\ T_J \le 150^{\circ}C \end{tabular}$
- $\ensuremath{\mathfrak{G}}$ Surface mounted on $\ensuremath{\,\text{FR-4}}$ board, $t \leq \ensuremath{\,\text{10sec}}.$

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IRF7504PbF

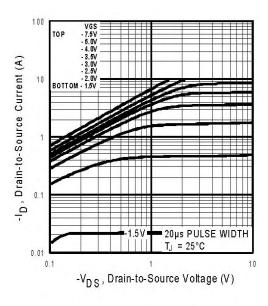


Fig 1. Typical Output Characteristics

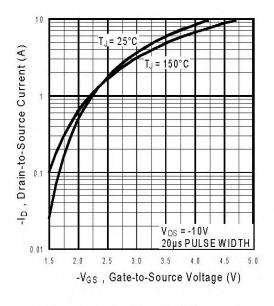


Fig 3. Typical Transfer Characteristics

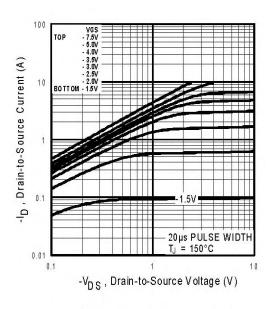


Fig 2. Typical Output Characteristics

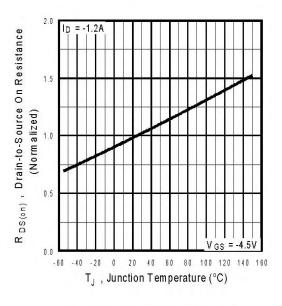


Fig 4. Normalized On-Resistance Vs. Temperature

International Rectifier

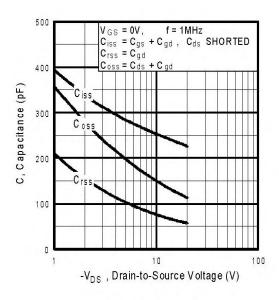


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

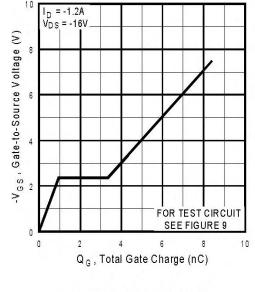


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

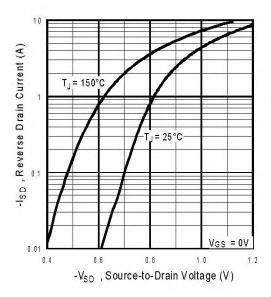


Fig 7. Typical Source-Drain Diode Forward Voltage

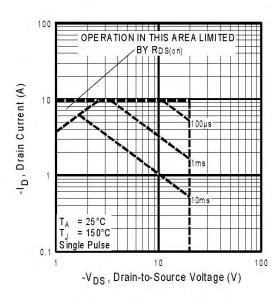
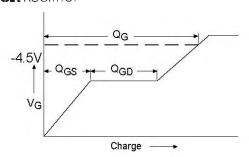


Fig 8. Maximum Safe Operating Area

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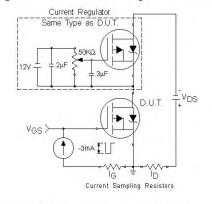
IRF7504PbF



 V_{DS} V_{GS} V_{DS} V_{DU} V_{DU} V

Fig 9a. Basic Gate Charge Waveform

Fig 10a. Switching Time Test Circuit



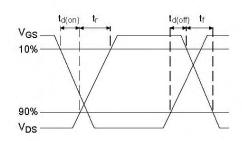


Fig 9b. Gate Charge Test Circuit

Fig 10b. Switching Time Waveforms

5

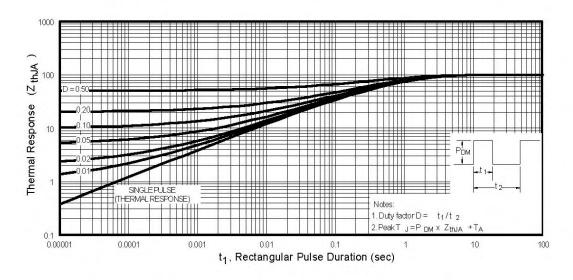
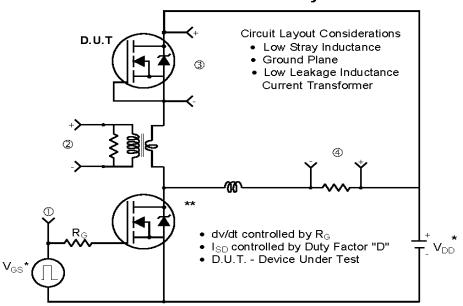
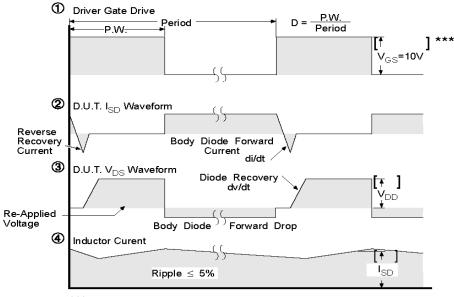


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient www.irf.com

Peak Diode Recovery dv/dt Test Circuit



- * Reverse Polarity for P-Channel
- ** Use P-Channel Driver for P-Channel Measurements

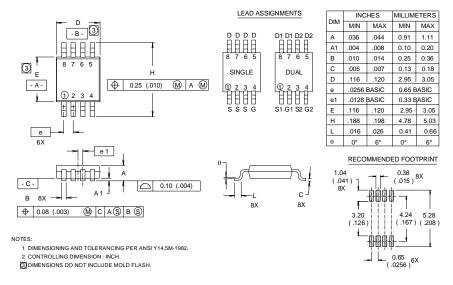


*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices

Fig 12. For P-Channel HEXFETS

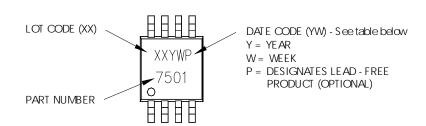
Micro8 Package Outline

Dimensions are shown in milimeters (inches)



Micro8 Part Marking Information

EXAMPLE: THIS IS AN IRF7501



WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

WW = (27-52) IF PRECEDED BY ALETTER

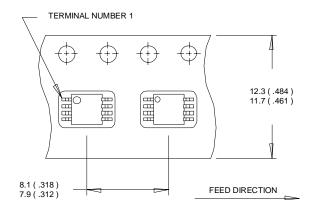
YE AR	Υ	WORK WEEK	W
2001	1	01	Α
2002	2	02	В
2003	3	03	С
2004	4	04	D
2005	5	1	1
2006	6		
2007	7		
2008	8	1	1
2009	9	7	1
2010	0	24	Χ
		25	Υ
		26	Z

YEAR	Υ	WORK WEEK	W
2001	Α	27	Α
2002	В	28	В
2003	С	29	С
2004	D	30	D
2005	Ε	1	1
2006	F		
2007	G		
2008	Н	1	1
2009	J	7	7
2010	K	50	Χ
		51	Υ
		52	Z

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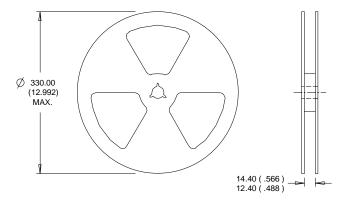
Micro8 Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- OUTLINE CONFORMS TO EIA-481 & EIA-541.
 CONTROLLING DIMENSION: MILLIMETER.



- 1. CONTROLLING DIMENSION : MILLIMETER. 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualifications Standards can be found on IR's Web site.



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